

Application

- \cdot Motor drive
- \cdot Converter
- · Photovoltaics, wind power generation.

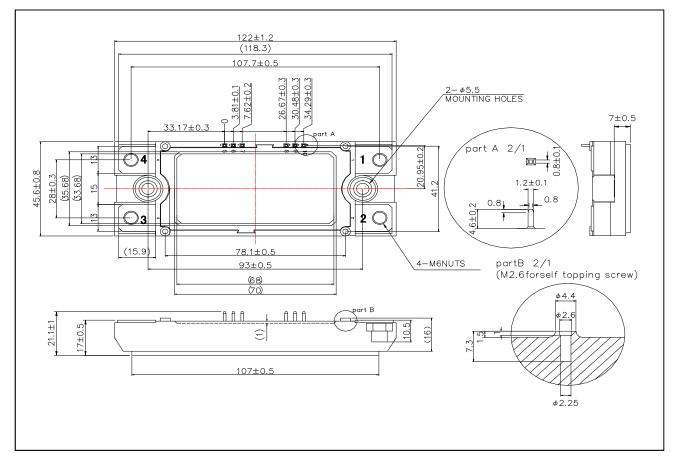
Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

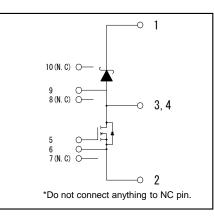
Construction

This product is a chopper module consisting of SiC-DMOSFET and SiC-SBD from ROHM.

•Dimensions & Pin layout (Unit : mm)



●Circuit diagram



 Absolute 	maximum	ratings	$(T_{i} = 25^{\circ}C)$
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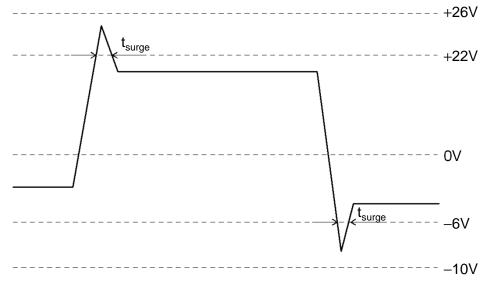
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Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	V_{DSS}	G-S short	1200		
Repetitive reverse voltage	V_{DSS}	Clamp diode	1200		
Gate-source voltage(+)	V	D-S short	22	V	
Gate-source voltage(-)	V_{GSS}		-6		
G - S Voltage (t _{surge} <300ns)	V_{GSS_surge}	D-S short	-10 to 26	1	
	I _D	DC (T _c =60°C)	134		
Drain current * ¹	I _{DRM}	Pulse (T _c =60°C) 1ms * ²	240		
	I _{DRM}	Pulse (T _c =60°C) 10us * ²	360		
	ا _s	DC (T _c =60°C) V _{GS} =18V	134	A	
Source current *1	I _{SRM}	Pulse (Tc=60°C) 1ms V _{GS} =18V * ²	240		
	I _{SRM}	Pulse (Tc=60°C) 10us V _{GS} =18V * ²	360		
	I _F	DC (T _c =60°C) V _{GS} =18V	134		
Forward curent (clamp diode) *1	I _{FRM}	Pulse (Tc=60°C) 1ms V _{GS} =18V * ²	240		
	I _{FRM}	Pulse (Tc=60°C) 10us V _{GS} =18V * ²	360	1	
Total power disspation *4	Ptot	T _c =25°C	935	W	
Max Junction Temperature	T _{jmax}		175		
Junction temperature	T _{jop}		-40 to150	°C	
Storage temperature	T _{stg}		-40 to125		
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min.	2500	Vrms	
Mounting torque		Main Terminals : M6 screw	4.5		
Mounting torque	—	Mounting to heat shink : M5 screw	3.5	N ∙ m	

(*1) Case temperature (T_c) is defined on the surface of base plate just under the chips.

(*2) Repetition rate should be kept within the range where temperature rise if die should not exceed $T_{j max}$.

(*3) T_j is less than 175°C

Example of acceptable $V_{\mbox{\scriptsize GS}}$ waveform



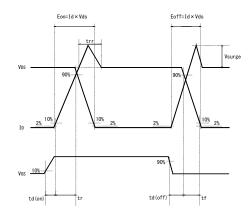
•Electrical characteristics (T_i=25°C)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit	
			T _j =25°C	-	2.1	3.2	V	
On-state static Drain-Source Voltage	V _{DS(on)}	I _D 120A, V _{GS} =18V	T _j =125°C	-	3.1	-		
			T _j =150°C	-	3.4	5.2		
Drain cutoff current	I _{DSS}	V _{DS} =1200V, V _{GS} =0V	-	-	10	μΑ		
	V _F		T _j =25°C	-	1.7	2.1	V	
Forwad Voltage		I _F =120A	T _j =125°C		2.2	-		
			T _j =150°C	-	2.4	3.2		
Reverse curent	I _{RRM}	Clamp diode	-	-	2	mA		
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =10V, I _D =22mA	1.6	-	4	V		
	I _{GSS}	V _{GS} =22V, V _{DS} =0V	-	-	0.5	μΑ		
Gate-source leakage current		V_{GS} = -6V, V_{DS} =0V	-0.5	-	-			
	t _{d(on)}	V _{GS(on)} =18V, V _{GS(off)} =0	-	30	-	ns		
	t _r	V _{DS} =600V	-	40	-			
Switching characteristics	t _{rr}	I _D =120A	-	20	-			
	t _{d(off)}	R _G =2.2Ω	-	165	-			
	t _f	inductive load	-	45	-			
Input capacitance	Ciss	V _{DS} =10V, V _{GS} =0V, 1N	-	14	-	nF		
Gate Registance	R _{Gint}	T _j =25°C	-	1.8	-	Ω		
Stray Inductance	Ls			25	-	nH		
Croopage Distance		Terminal to heat sink		12.5	-	mm		
Creepage Distance	-	Terminal to terminal		20	-	mm		
Clearance Distance	-	Terminal to heat sink			10.5	-	mm	
Clearance Distance		Terminal to terminal		14	-	mm		
Junction-to-case thermal	R _{th} (j-c)	DMOS (1/2 module) *	-	-	0.16	°C/W		
resistance		SBD (1/2 module) *4	-	-	0.21			
Case-to-heat sink Thermal resistance	R _{th} (c-f)	Case to heat sink, per Thermal grease applie	-	0.035	-	°C/vv		

(*4) Measurement of Tc is to be done at the point just under the chip.

- (*5) Typical value is measured by using thermally conductive grease of λ =0.9W/(m · K).
- (*6) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- (*7) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.

<Wavelength for Switching Test>





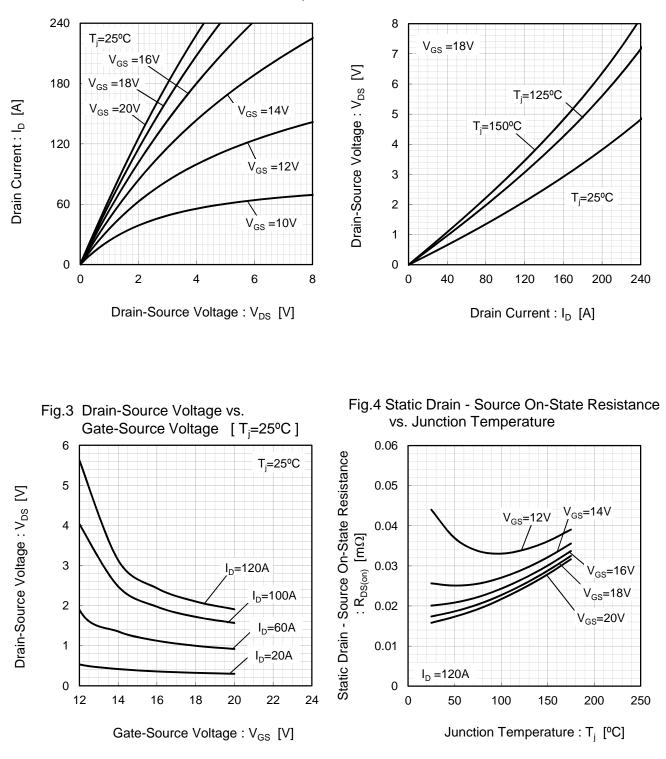


Fig.1 Typical Output Characteristics [T_j=25°C] Fig.2 Drain-Source Voltage vs. Drain Current

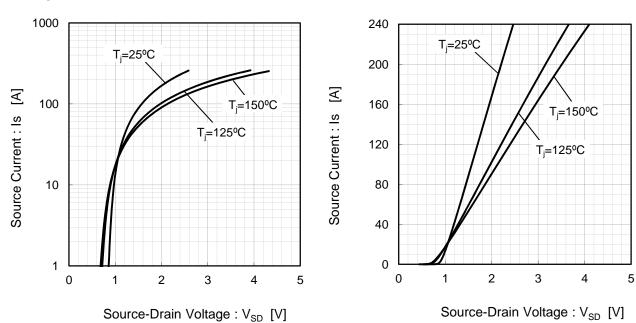
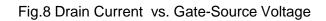
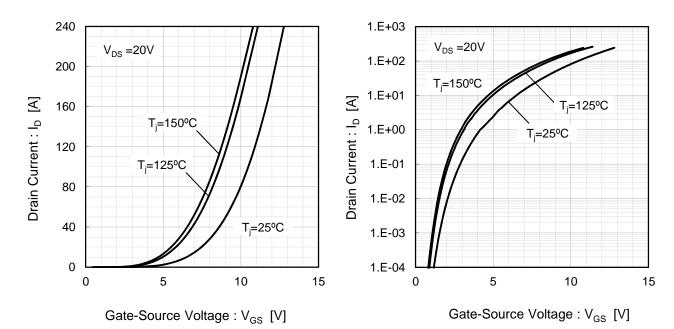


Fig.5 Forward characteristic of Diode

Fig.6 Forward characteristic of Diode

Fig.7 Drain Current vs. Gate-Source Voltage





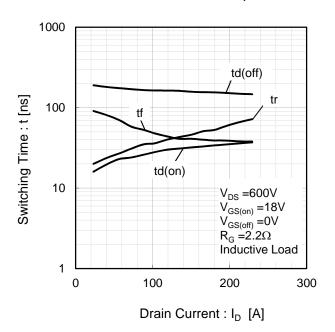


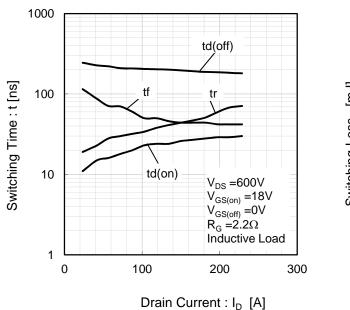
Fig.9 Switching Characteristics [T_i=25°C]

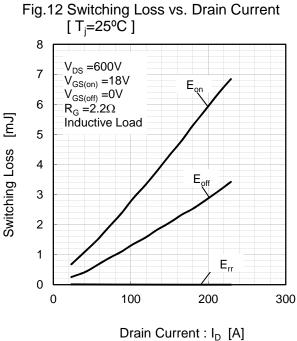
1000 td(off) Switching Time : t [ns] 100 tf tr td(on) 10 V_{DS} =600V $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ $R_G = 2.2\Omega$ Inductive Load 1 0 100 200 300

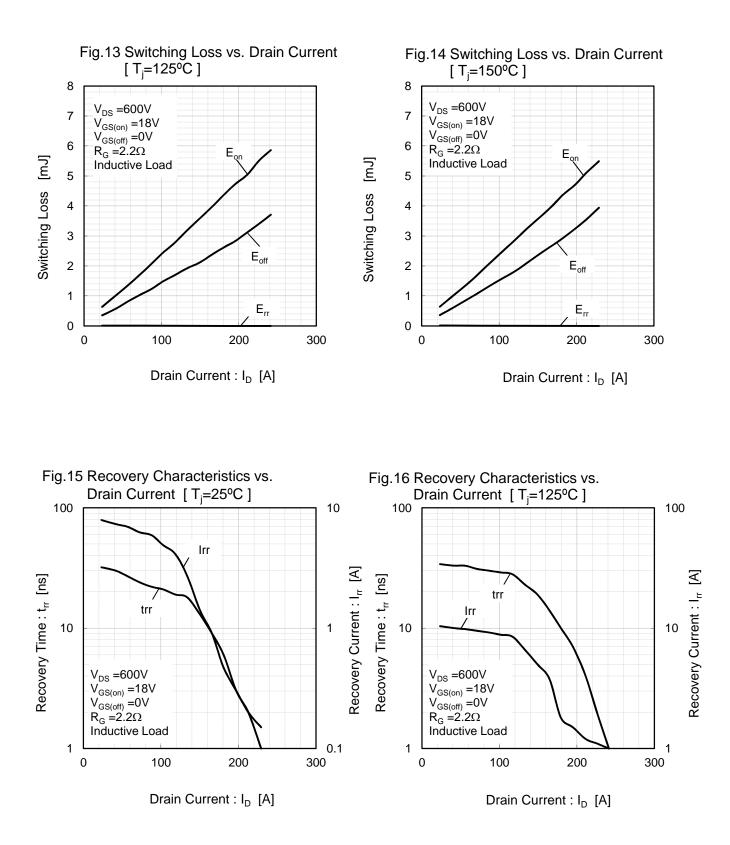
Fig.10 Switching Characteristics [T_i=125°C]

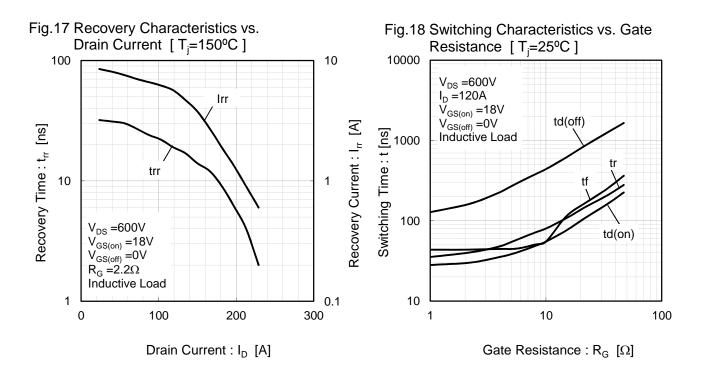
Drain Current : I_D [A]

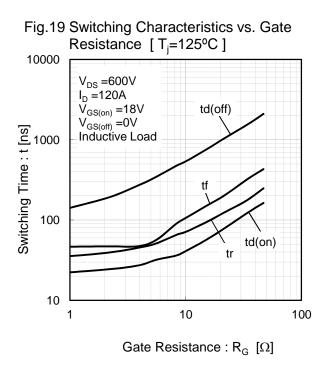
Fig.11 Switching Characteristics [T_i=150°C]

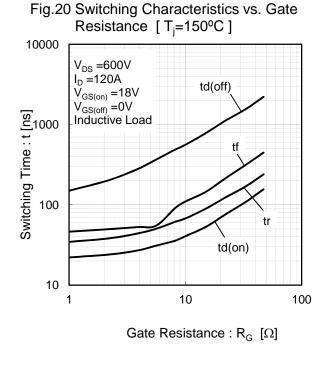


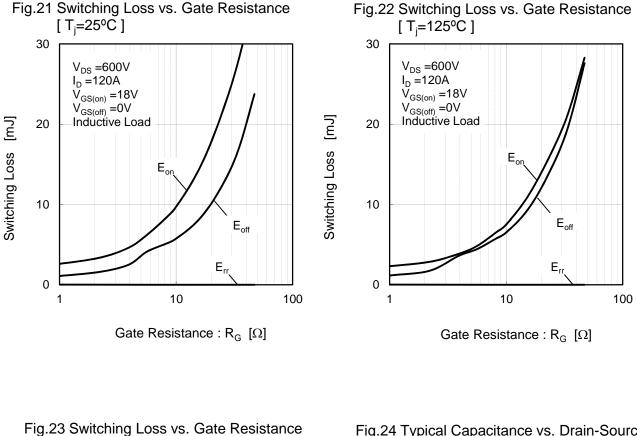


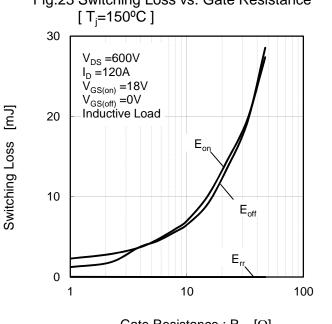






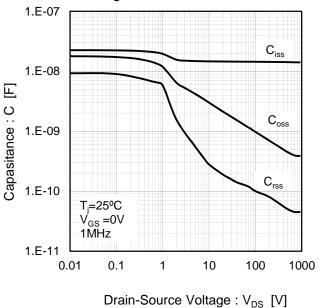


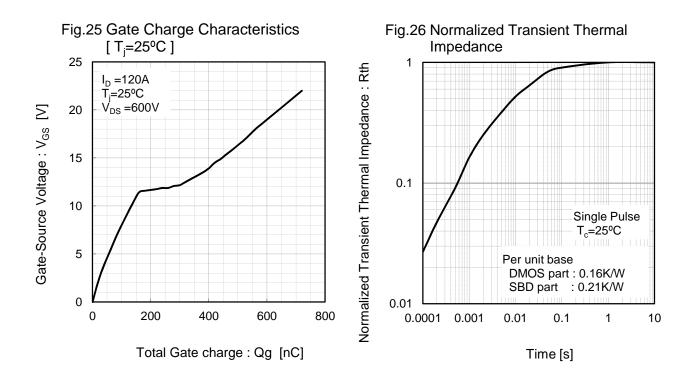




Gate Resistance : ${\rm R}_{\rm G}~\left[\Omega\right]$

Fig.24 Typical Capacitance vs. Drain-Source Voltage







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25.330.1653.1	25.330.4753.1	25.330.5253.1	25.334.3253.1	25.334.3353.1	25.350.2053.0	25.352.4753.1	25.522.3253.0	<u>T483C</u> <u>T484C</u>
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